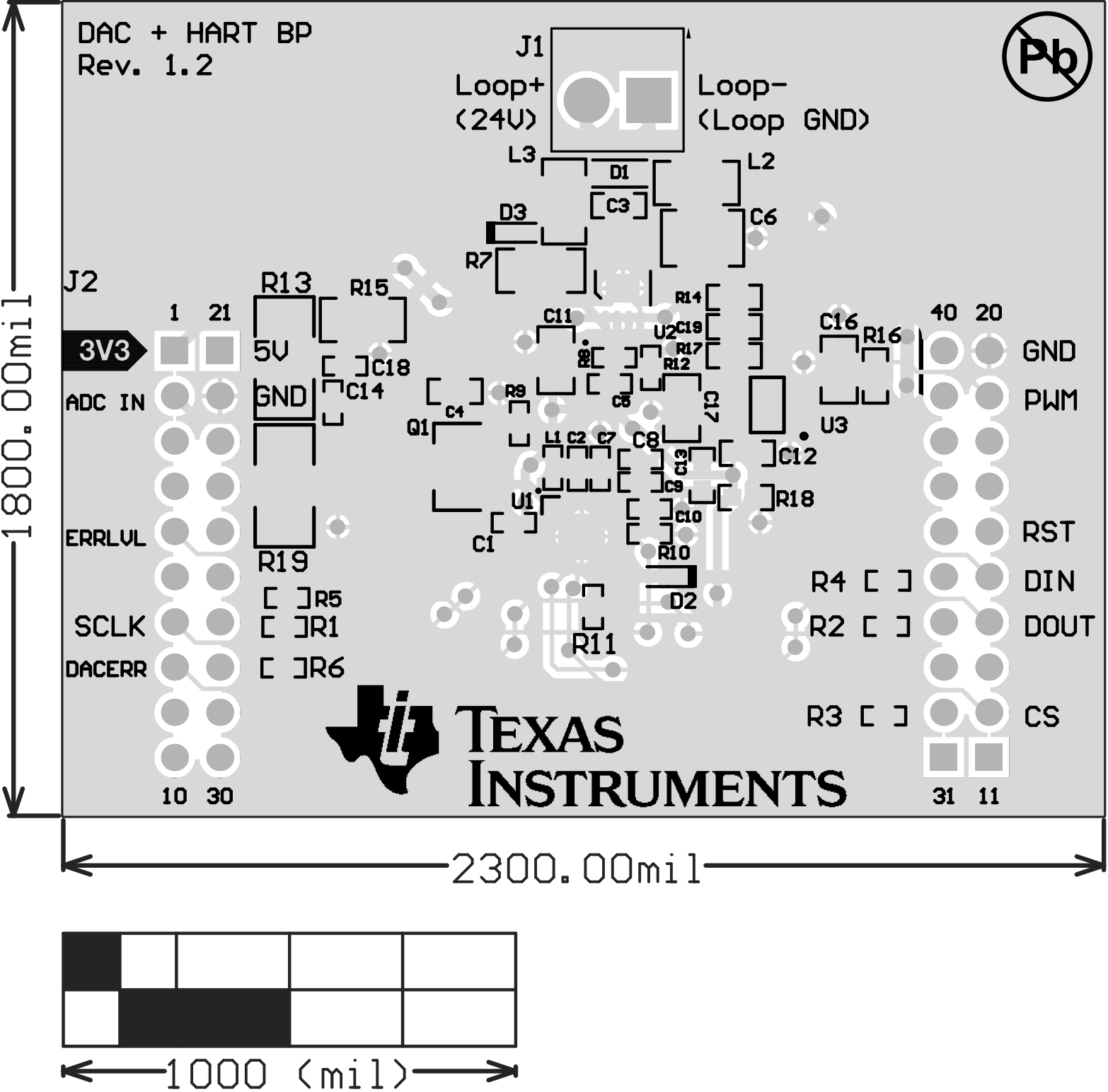
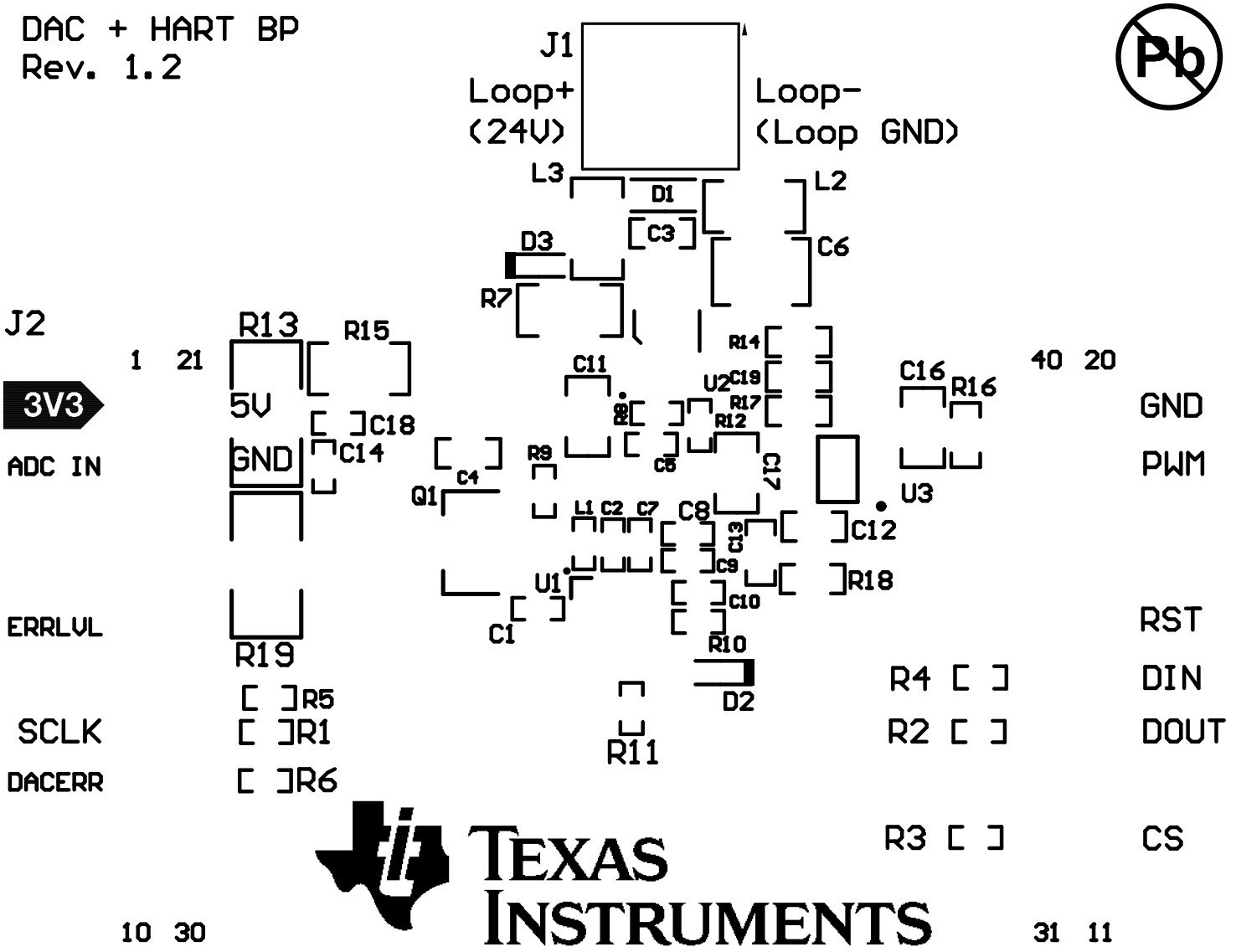

DAC + HART BP
Rev. 1.2
J1
Loop+
(24V)
Loop-
(Loop GND)
L3
D1
L2
C3
C6
D3
R7
J2
R13
R15
1
21
3V3
5V
GND
ADC IN
C18
C14
C11
R14
U2
C19
R17
R12
C16
R16
40
20
GND
PWM
R9
C5
C17
C4
Q1
L1
C2
C7
C8
U3
C12
C13
C9
U1
R18
C10
C1
R10
ERRLVL
R19
RST
R4
DIN
R5
SCLK
R1
D2
R11
R2
DOUT
DACERR
R6
R3
CS
TEXAS
INSTRUMENTS
10
30
31
11
1800.00mil
2300.00mil
1000 (mil)


DAC + HART BP
Rev. 1.2
J1
Loop+
(24V)
Loop-
(Loop GND)
L3
D1
L2
C3
C6
D3
R7
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R13
R15
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ADC IN
GND
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C11
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C16
R16
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GND
R17
R12
R9
C5
C17
PWM
C4
Q1
L1
C2
C7
C8
U3
C12
C13
C9
R18
U1
C10
C1
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R19
R10
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R4
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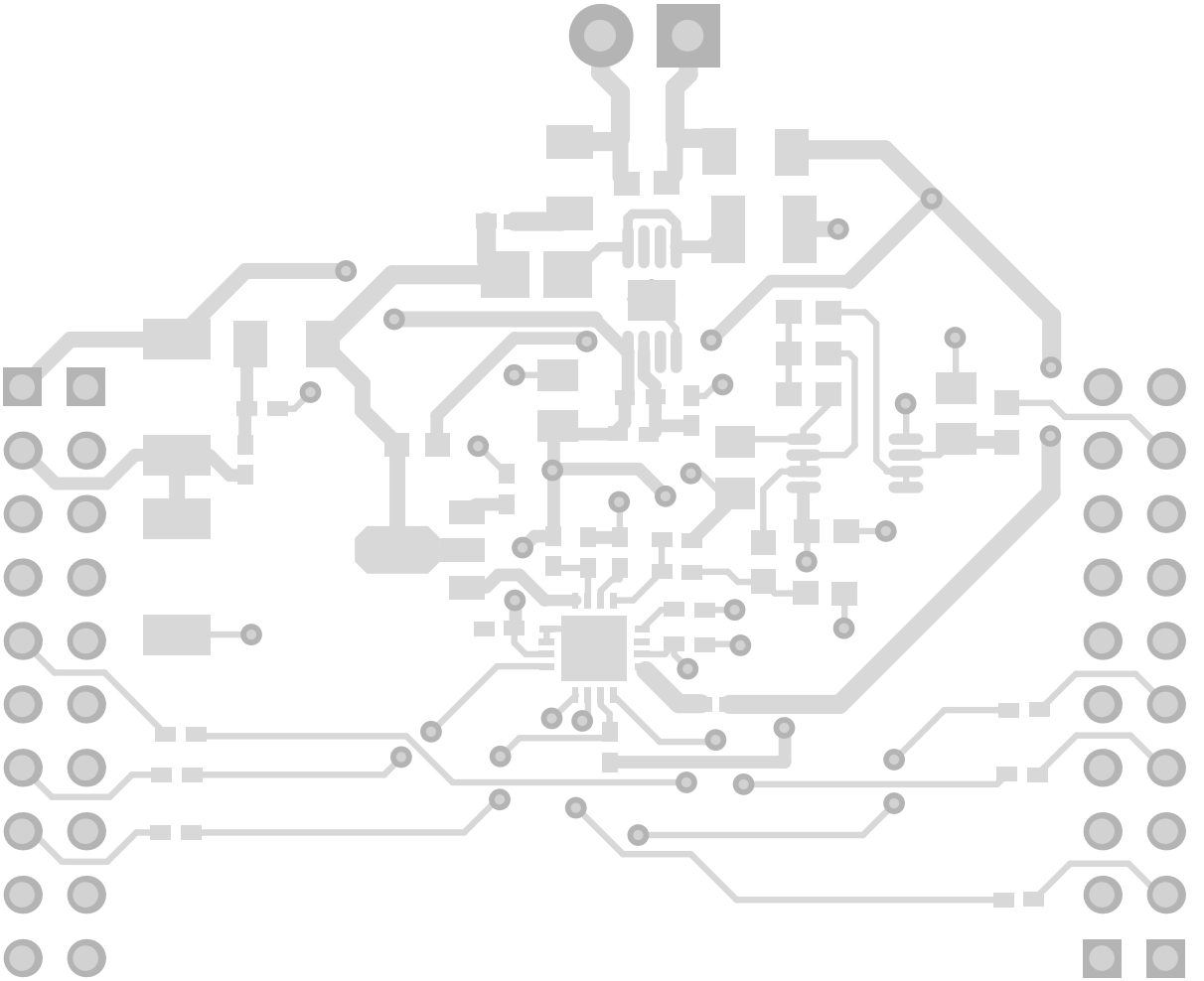
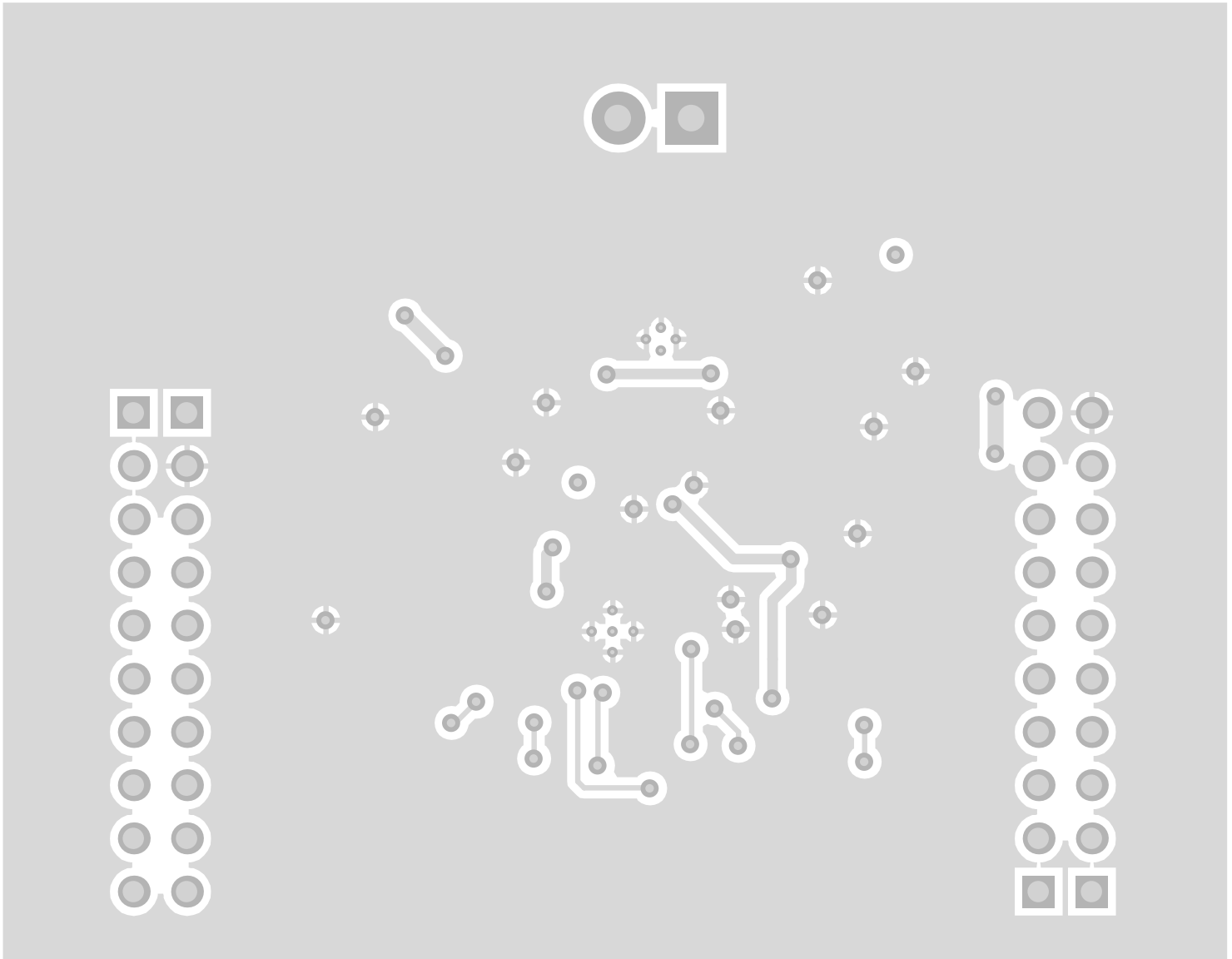
D2
SCLK
R1
R11
R2
DOUT
DACERR
R6
R3
CS
TEXAS
INSTRUMENTS
10
30
31
11



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